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MOSFET – Power, Single N-Channel

80 V, 157 A, 2.8 mΩ

NVMFS6H801N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS6H801NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parar	neter		Value	Unit
V _{DSS}	Drain-to-Source Voltag	80	V		
V _{GS}	Gate-to-Source Voltage	Э		±20	V
Ι _D	Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	157	А
	Current R _{θJC} (Notes 1, 3)	Sidle	T _C = 100°C	111	
PD	Power Dissipation		$T_{C} = 25^{\circ}C$	166	W
	R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$	83	
Ι _D	Continuous Drain Current R _{θJA}	Steady State	T _A = 25°C	23	А
	(Notes 1, 2, 3)	Sidle	T _A = 100°C	16	
PD	Power Dissipation		T _A = 25°C	3.8	W
	R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$	1.9	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	900	А
T _J , T _{stg}	Operating Junction and Storage Temperature Range			–55 to +175	°C
۱ _S	Source Current (Body Diode)			138	А
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 12.2 A)			960	mJ
TL	Lead Temperature for S (1/8" from case for 10 s		Purposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	0.9	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	2.8 mΩ @ 10 V	157 A



DFN5 (SO-8FL) CASE 488AA STYLE 1

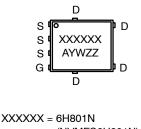


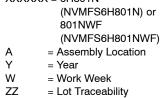
CASE 507BA

G (4) O S (1,2,3)

N-CHANNEL MOSFET

MARKING DIAGRAM





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARA	ACTERISTICS						
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		80			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				38		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 80 V	T _J = 25 °C			10	μΑ
		$v_{\rm DS} = 80 v$	$T_J = 125^{\circ}C$			100	
I _{GSS}	Gate-to-Source Leakage Current	V_{DS} = 0 V, V_{GS} = 20 V				100	nA

ON CHARACTERISTICS (Note 4)

V _{GS(TH)}	Gate Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250\;\mu A$		2.0		4.0	V
V _{GS(TH)} /T _J	Threshold Temperature Coefficient				7.2		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 50 A		2.3	2.8	mΩ
9 _{FS}	Forward Transconductance	V_{DS} =15 V, I_{D} = 50 A			128		S

CHARGES, CAPACITANCES & GATE RESISTANCE

C _{ISS}	Input Capacitance	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 40 V	4120	pF
C _{OSS}	Output Capacitance		586	
C _{RSS}	Reverse Transfer Capacitance		22	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 40 V; I_{D} = 50 A	64	nC
Q _{G(TH)}	Threshold Gate Charge	V_{GS} = 10 V, V_{DS} = 40 V; I_{D} = 50 A	11	
Q _{GS}	Gate-to-Source Charge		19	
Q _{GD}	Gate-to-Drain Charge		13	
V _{GP}	Plateau Voltage		5.0	V

SWITCHING CHARACTERISTICS (Note 5)

t _{d(ON)}	Turn-On Delay Time	$V_{GS} = 10 \text{ V}, V_{DS} = 64 \text{ V},$	25	ns
tr	Rise Time	$I_{\rm D}$ = 50 A, R _G = 2.5 Ω	74	
t _{d(OFF)}	Turn-Off Delay Time		70	
t _f	Fall Time		19	

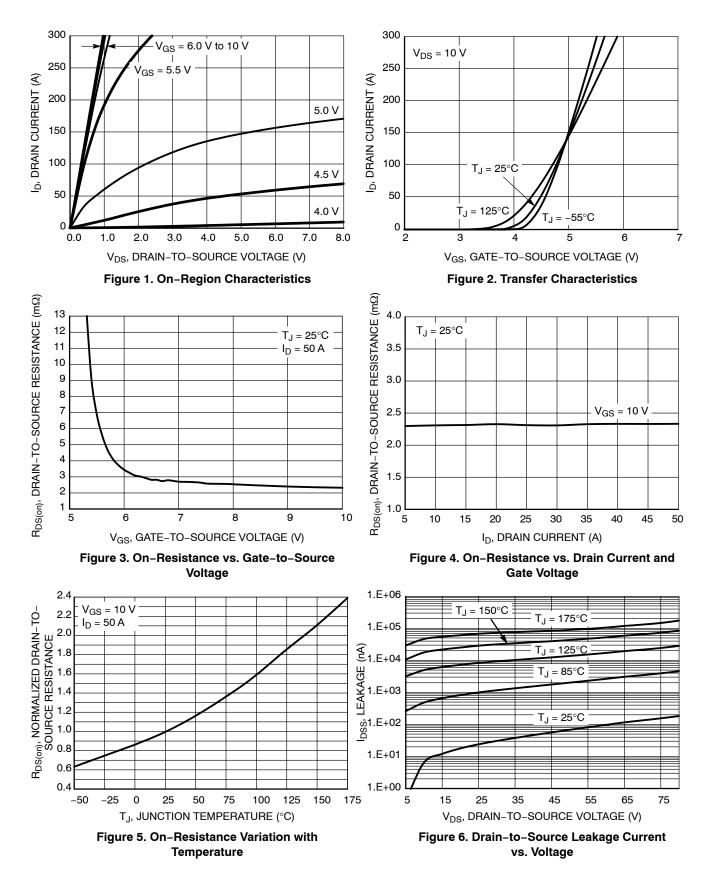
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$	0.8	1.2	V
		$I_{S} = 50 \text{ A}$	T _J = 125°C	0.7		
t _{RR}	Reverse Recovery Time	$V_{GS} = 0 V$, dIS/dt = 10	0 A/μs,	64		ns
t _a	Charge Time	I _S = 50 A		36		
t _b	Discharge Time			28		
Q _{RR}	Reverse Recovery Charge			98		nC

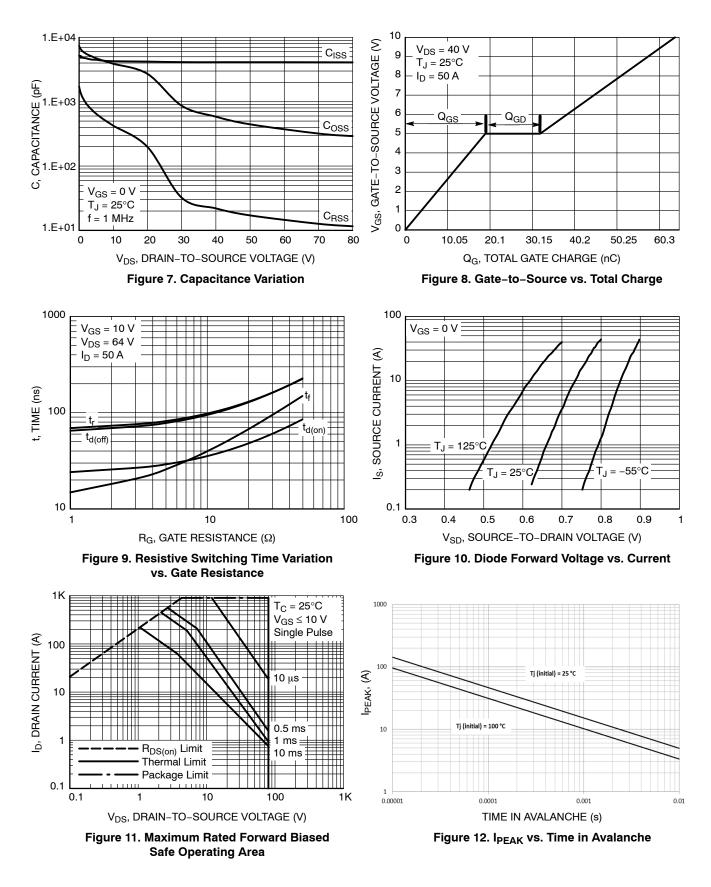
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

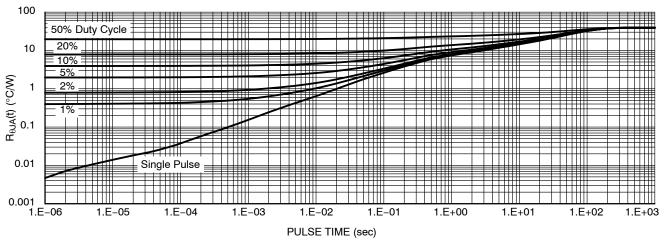


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS6H801NT1G	6H801N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS6H801NT3G	6H801N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS6H801NWFT1G	801NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

DEVICE ORDERING INFORMATION

DISCONTINUED (Note 6)

NVMFS6H801NWFT3G	801NWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
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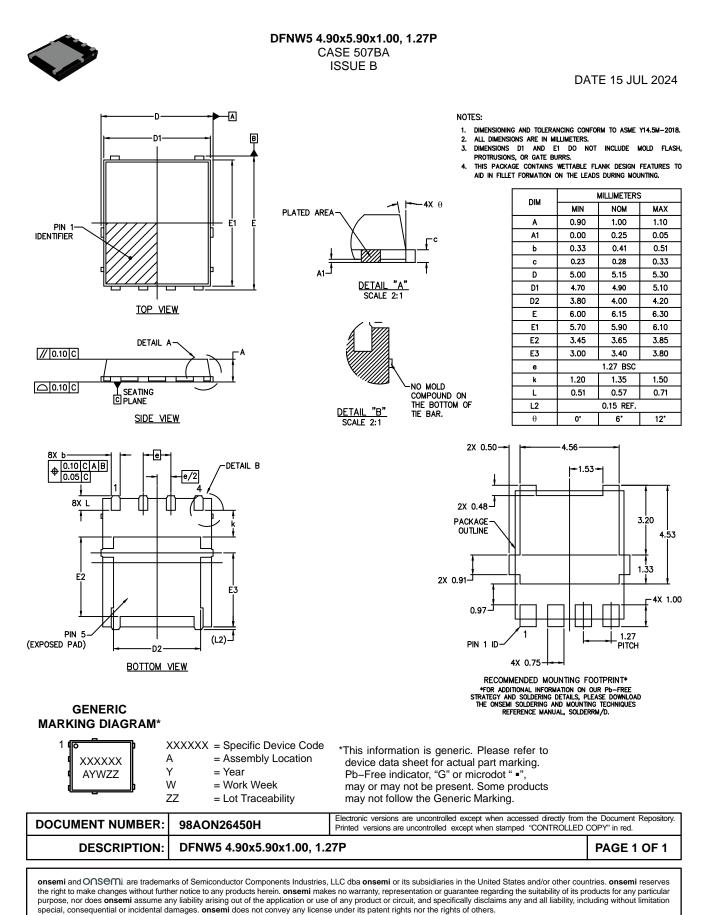
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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